

P-Channel 100 V (D-S) MOSFET

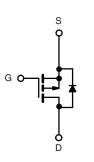
PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)		
- 100	0.215 at V _{GS} = - 10 V	- 12	11		
- 100	0.234 at V _{GS} = - 4.5 V	- 10	11		

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET ٠
- 100 % R_g and UIS Tested
 Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Power Switch
- DC/DC Converters



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 100	v	
Gate-Source Voltage		V _{GS}	± 20	v
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 25 °C	1-	- 12	
Continuous Drain Current $(1_j = 150^{\circ} C)$	T _C = 70 °C	I _D	- 8	A
Pulsed Drain Current		I _{DM}	- 30	A
Avalanche Current		I _{AS}	- 20	
Single Avalanche Energy ^a L = 0.1 mH		E _{AS}	16.2	mJ
	T _C = 25 °C	P	32.1 ^b	14/
Maximum Power Dissipation ^a	T _A = 25 °C ^c	– P _D –	2.5	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

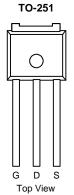
THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W	
Junction-to-Case (Drain)	R _{thJC}	3.9	0/11	

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).





COMPLIANT HALOGEN FREE

9	3	®	Bs	sem	i
W	ww.\	/Bs	sen	ni.con	n

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 V, I_D = -250 \mu A$	- 100			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 2.5	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50		
		V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 150 °C			- 250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 10 V, V_{GS} = - 10 V	- 15			А	
	B	V _{GS} = - 10 V, I _D = - 3.6 A		0.215		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 3.4 A		0.234			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 3.6 A		12		S	
Dynamic ^b		· · · ·					
Input Capacitance	C _{iss}			1055			
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 50 V, f = 1 MHz		65		pF	
Reverse Transfer Capacitance	C _{rss}			41			
Tatal Oata Oharma ⁶	Qg	$V_{DS} = -50 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.6 \text{ A}$		23		nC	
Total Gate Charge ^c				11			
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -50 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3.6 \text{ A}$		3.5			
Gate-Drain Charge ^c	Q _{gd}			4.8			
Gate Resistance	Rg	f = 1 MHz	1.2	5.7	11.5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			7	14		
Rise Time ^c	t _r	V_{DD} = - 50 V, R_L = 17.2 Ω		12	18	20	
Turn-Off Delay Time ^c	t _{d(off)}	$I_{D} \cong$ - 2.9 A, V_{GEN} = - 10 V, R_{g} = 1 Ω		33	50	ns	
Fall Time ^c	t _f]		9	18		
Drain-Source Body Diode Ratings a	nd Characteri	istics T _C = 25 °C ^b					
Continuous Current	ا _S				- 8.8		
Pulsed Current	I _{SM}				- 15	- A	
Forward Voltage ^a	V _{SD}	I _F = - 2.9 A, V _{GS} = 0 V		- 0.8	- 1.5	V	
Reverse Recovery Time	t _{rr}			50	75	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	Α	
Reverse Recovery Charge	Q _{rr}	1 1		98	147	nC	

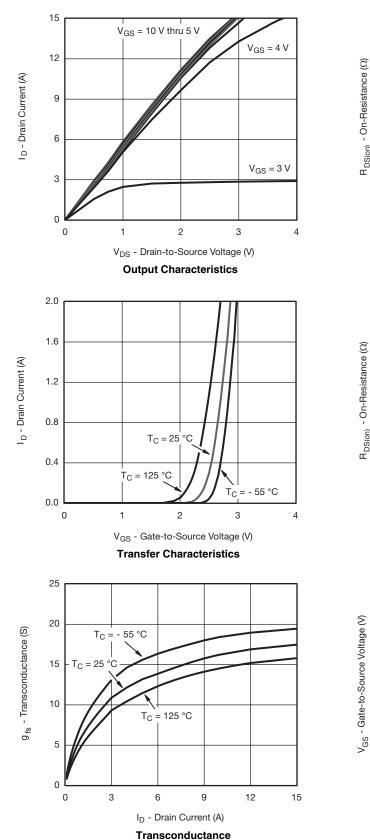
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

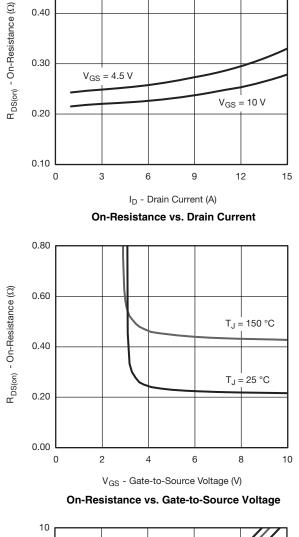
b. Guaranteed by design, not subject to production testing.c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



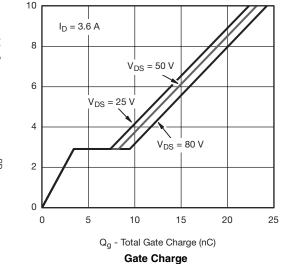


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



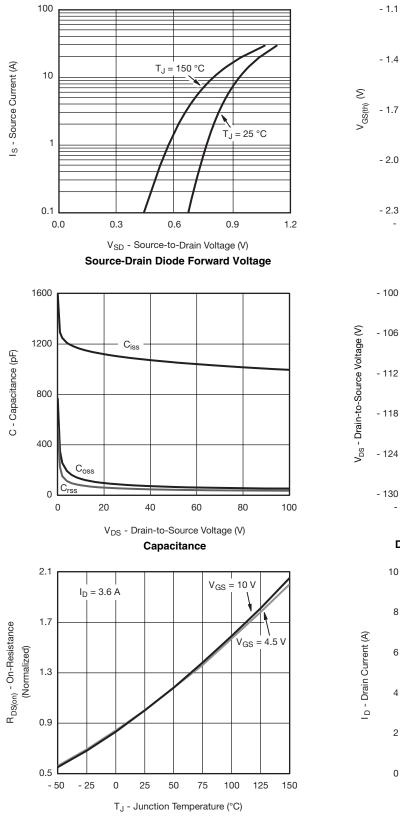
0.50

0.40

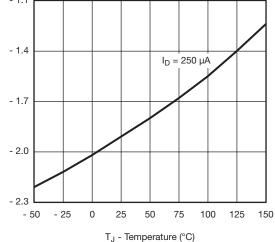




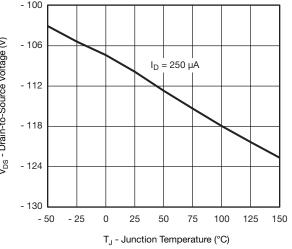
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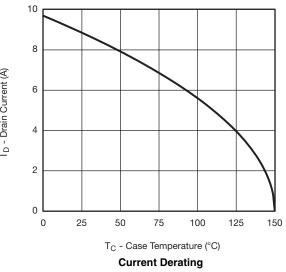
On-Resistance vs. Junction Temperature



Threshold Voltage

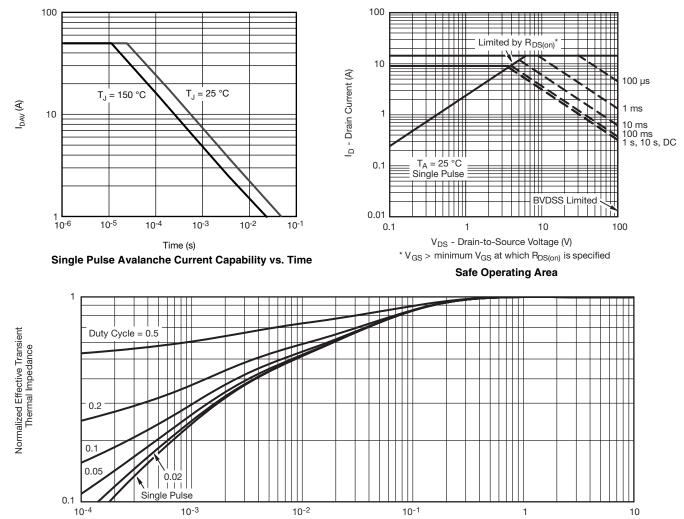


Drain Source Breakdown vs. Junction Temperature





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

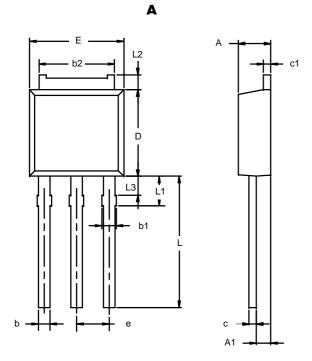


Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Case

IRFU9110PBF



TO-251AA



Note: Dimension L3 is for reference only.

	MILLIMETERS		INC	HES	
Dim	Min	Мах	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28	2.28 BSC		BSC	
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	
ECN: S-0 DWG: 53	3946—Rev. E 346	E, 09-Jul-01			



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